

Ultra-Miniature Pushbutton Switches



RoHS Compliant



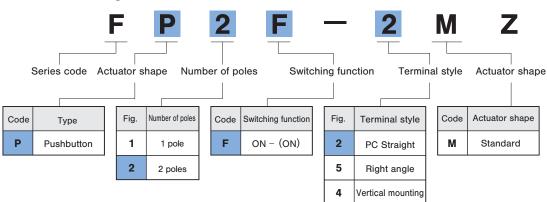
Features -

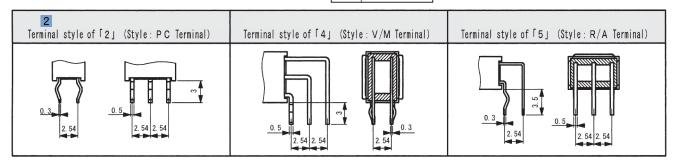
- 1. Ultra-miniature pushbutton switch for high density mounting.
- 2. Washable.
- 3. Terminal pin pitch: 2.54 mm.
- 4. Independent detent mechanism ensures light operational feel.
- 5. Clip contact mechanism for long-term contact reliability.
- 6. Gold-plated contacts.

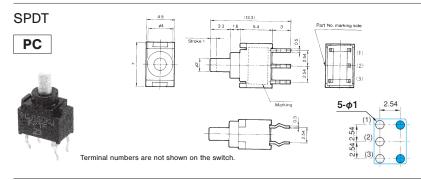
■ Specification -

Rating	Max.	0.4VA (28VDC max.)		
	Min.	1μA 20mVDC		
Initial contact resistance		100m $Ω$ max.	(1.5mA 200µVAC)	
Dielecteic strength		250VAC 1 minute		
Insulation resistance		500M $Ω$ min.	(250VDC)	
Electrical life		10,000 operations at max.rating, 30,000 operations at min.rating,		
Mechanical life		30,000 cycles		
Operating force		1.47±0.98N		
Operating temperature range		-40∼+85°C		
Storage temperature range		-40∼+85°C		

Part Numbering

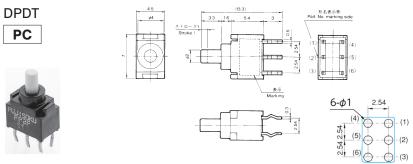






Switching function Part No.	1	±
FP1F-2M-Z	ON	(ON)
Connecting terminals	2-3	2-1

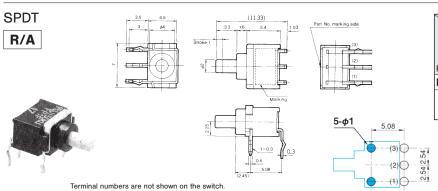
(Top view) PC Hole Layouts



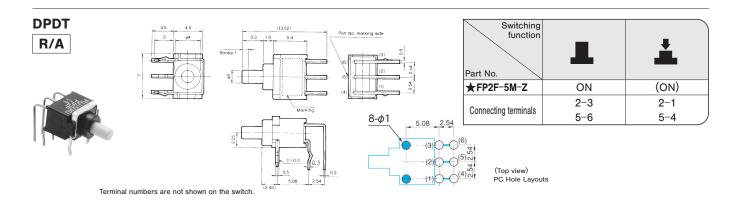
Terminal numbers are not shown on the switch

Switching function Part No.	1	±
★FP2F-2M-Z	ON	(ON)
Connecting terminals	2-3	2-1
Connecting terminals	5-6	5-4

(Top view) PC Hole Layouts



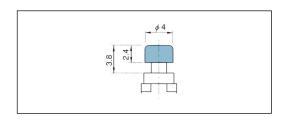
Switching function	ı	
Part No. FP1F-5M-Z	ON	(ON)
Connecting terminals	2-3	2-1



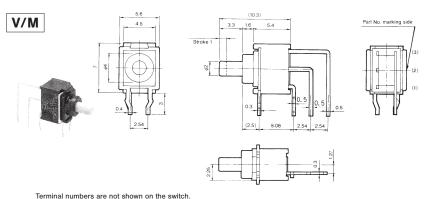
Optional Accessories

			«Sold separately»
Part Name	Dimension	Color	Part Number
	Gloss finish	White	140000481453
Color Cap	 	Red	140000481452
	44	Black	140000481451
	ABS resin	Gray	140000481450

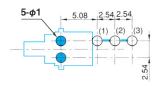
■Color Cap Mounting



SPDT



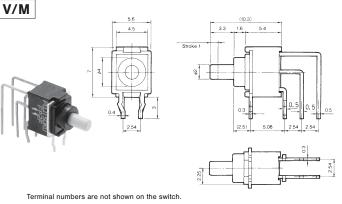
Switching function	ı	±
FP1F-4M-Z	ON	(ON)
Connecting terminals	2-3	2-1



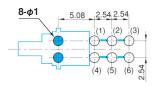
(Top view) PC Hole Layouts

reminar numbers are not shown on the switch.

DPDT



Switching function Part No.	1	±
★FP2F-4M-Z	ON	(ON)
Connecting terminals	2-3 5-6	2-1 5-4



(Top view) PC Hole Layouts

■ Handling Precautions (FP, FT, FL)

1. Soldering Specifications

(1)Manual Soldering

Device: Soldering iron

380°C, Max.; 3 seconds, Max.

(2)Auto soldering

Device: Jet wave type or dip type 275°C, Max.; 6 seconds, Max.

- Pre-heating should be done at temperatures from 80 to 120°C and within 120 seconds.
- (3)When soldering two or more terminals to the common land, use solder resist to solder them independently.

2. Flux Cleaning

- (1)Solvents :Fluorine or Alcohol type
- (2)Cleaning after soldering should be done after the PC board is exposed to room temperature (30°C or below) for 1 to 2 hours.
- (3)Do not use ultrasonic cleaning.

■ Packaging Specifications

